## 503420827 08/03/2015

# PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

## **CONVEYING PARTY DATA**

Name	Execution Date
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MOTOYUKI ABE	06/26/2015
YOSHIHITO YASUKAWA	07/03/2015
KIYOTAKA OGURA	07/13/2015
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TOHRU ISHIKAWA	07/13/2015

### **RECEIVING PARTY DATA**

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## **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	14765489

## **CORRESPONDENCE DATA**

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ATTORNEY DOCKET NUMBER:	106734.68113US	
NAME OF SUBMITTER:	RICHARD R. DIEFENDORF	
SIGNATURE:	/Richard R. Diefendorf, Reg. No. 32,390/	
DATE SIGNED:	08/03/2015	

**Total Attachments: 1** 

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PATENT REEL: 036240 FRAME: 0901

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### ASSIGNMENT

( 譲渡証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by H!TACH! AUTOMOTIVE SYSTEMS, LTD., a corporation organized under the laws of Japan, located at 2520, Takaba, Hitachinaka-shi, Ibaraki, Japan, receipt of which is hereby acknowledged I do hereby sell and assign to said HITACHI AUTOMOTIVE SYSTEMS, LTD., its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

#### **FUEL INJECTION VALVE**

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said HITACHI AUTOMOTIVE SYSTEMS, LTD., its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said HITACHI AUTOMOTIVE SYSTEMS, LTD.

Signed on the date(s) indicated aside our signatures:

INVENTOR(S) (発明者フルネームサイン)	Date Signed (署名日)
1) EIJI ISHII Zigi Ishir	3/3/2015
2) Motoyuki ABE Moroyuh' ale	6/26/2015
3) Yoshihito YASUKAWA Yorkahit Janafaria	7/3/2015
4) Kiyotaka OGURA Kiyotaka Ogura	7/18/2015
5) Hideharu EHARA	7/14/2015
6) Tohru ISHIKAWA John Infrance	7/13/2015
7)	
8)	
9)	
10)	·

**PATENT** REEL: 036240 FRAME: 0902

RECORDED: 08/03/2015